

November 2013

# FQD7N20L

# N-Channel QFET® MOSFET

200 V, 5.5 A, 750 mΩ

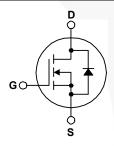
# **Description**

This N-Channel enhancement mode power MOSFET is produced using Fairchild Semiconductor's proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state resistance, and to provide superior switching performance and high avalanche energy strength. These devices are suitable for switched mode power supplies, active power • 100% Avalanche Tested factor correction (PFC), and electronic lamp ballasts.

## **Features**

- 5.5 A, 200 V,  $R_{DS(on)}$  = 750 m $\Omega$  (Max.) @  $V_{GS}$  = 10 V,  $I_D = 2.75 A$
- Low Gate Charge (Typ. 6.8 nC)
- Low Crss (Typ. 8.5 pF)
- RoHS Compliant
- · Low Level Gate Drive Requirement Allowing Direct Operating from Logic Drivers





# Absolute Maximum Ratings T<sub>C</sub> = 25°C unless otherwise noted.

Symbol	Parameter	FQD7N20LTM	Unit	
$V_{DSS}$	Drain-Source Voltage	200	V	
I <sub>D</sub>	Drain Current - Continuous (T <sub>C</sub> = 25°C)	5.5	Α	
	- Continuous (T <sub>C</sub> = 100°C)	3.48	А	
I <sub>DM</sub>	Drain Current - Pulsed (Note 1)	22	Α	
V <sub>GSS</sub>	Gate-Source Voltage	± 20	V	
E <sub>AS</sub>	Single Pulsed Avalanche Energy (Note 2)	73	mJ	
I <sub>AR</sub>	Avalanche Current (Note 1)	5.5	Α	
E <sub>AR</sub>	Repetitive Avalanche Energy (Note 1)	4.5	mJ	
dv/dt	Peak Diode Recovery dv/dt (Note 3)	5.5	V/ns	
$P_{D}$	Power Dissipation (T <sub>A</sub> = 25°C) *	2.5	W	
	Power Dissipation (T <sub>C</sub> = 25°C)	45	W	
	- Derate above 25°C	0.36	W/°C	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range	-55 to +150	°C	
T <sub>L</sub>	Maximum lead temperature for soldering, 1/8" from case for 5 seconds	300	°C	

## Thermal Characteristics

Symbol	Parameter	FQD7N20LTM	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max. 2.78		
D.	Thermal Resistance, Junction to Ambient (Minimum Pad of 2-oz Copper), Max.	110	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient (*1 in <sup>2</sup> Pad of 2-oz Copper), Max.	50	

# **Package Marking and Ordering Information**

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FQD7N20LTM	FQD7N20L	DPAK	Tape and Reel	330 mm	16 mm	2500 units

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
Off Cha	aracteristics					
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	200			V
ΔBV <sub>DSS</sub> / ΔT <sub>J</sub>	Breakdown Voltage Temperature Coefficient	$I_D$ = 250 $\mu$ A, Referenced to 25°C		0.17		V/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 200 V, V <sub>GS</sub> = 0 V			1	μΑ
		V <sub>DS</sub> = 160 V, T <sub>C</sub> = 125°C			10	μΑ
I <sub>GSSF</sub>	Gate-Body Leakage Current, Forward	V <sub>GS</sub> = 20 V, V <sub>DS</sub> = 0 V			100	nA
I <sub>GSSR</sub>	Gate-Body Leakage Current, Reverse	V <sub>GS</sub> = -20 V, V <sub>DS</sub> = 0 V			-100	nA
On Cha	aracteristics					
V <sub>GS(th)</sub>	Gate Threshold Voltage	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250 μA	1.0		2.0	V
R <sub>DS(on)</sub>	Static Drain-Source	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 2.75 A		0.59	0.75	
- DS(011)	On-Resistance	V <sub>GS</sub> = 5 V, I <sub>D</sub> = 2.75 A		0.62	0.78	Ω
9 <sub>FS</sub>	Forward Transconductance	V <sub>DS</sub> = 30 V, I <sub>D</sub> = 2.75 A		5.6		S
Dunam	ia Charactariatica				1	
C <sub>iss</sub>	Input Capacitance  Vac = 25 V. Vac = 0 V			390	500	pF
Coss	Output Capacitance	$V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V},$		55	70	pΓ
C <sub>rss</sub>	Reverse Transfer Capacitance	f = 1.0 MHz		8.5	11	рF
9188	Treverse Transfer Supusitance			0.0	• • •	Pi
Switchi	ing Characteristics					
t <sub>d(on)</sub>	Turn-On Delay Time	V <sub>DD</sub> = 100 V, I <sub>D</sub> = 6.5 A,		12	35	ns
t <sub>r</sub>	Turn-On Rise Time	$R_G = 25 \Omega$		125	260	ns
t <sub>d(off)</sub>	Turn-Off Delay Time	(Note 4)		20	50	ns
t <sub>f</sub>	Turn-Off Fall Time			65	140	ns
Qg	Total Gate Charge	$V_{DS} = 160 \text{ V}, I_{D} = 6.5 \text{ A},$		6.8	9.0	nC
$Q_{gs}$	Gate-Source Charge	$V_{GS} = 5 V$ (Note 4)		1.6		nC
$Q_{gd}$	Gate-Drain Charge			3.4		nC
Drain-S	Source Diode Characteristics a	nd Maximum Ratings				
I <sub>S</sub>	Source Diode Characteristics and Maximum Ratings  Maximum Continuous Drain-Source Diode Forward Current				5.5	Α
I <sub>SM</sub>	Maximum Pulsed Drain-Source Diode Forward Current				22	Α
V <sub>SD</sub>	Drain-Source Diode Forward Voltage	V <sub>GS</sub> = 0 V, I <sub>S</sub> = 5.5 A			1.5	V
t <sub>rr</sub>	Reverse Recovery Time	V <sub>GS</sub> = 0 V, I <sub>S</sub> = 6.5 A,		110		ns
Q <sub>rr</sub>	Reverse Recovery Charge	dI <sub>F</sub> / dt = 100 A/μs		0.44	//	μС

Notes: 1. Repetitive rating : pulse-width limited by maximum junction temperature. 2. L = 3.6 mH, I $_{AS}$  = 5.5 A, V $_{DD}$  = 50 V, R $_{G}$  = 25  $\Omega$ , starting T $_{J}$  = 25°C. 3. I $_{SD}$  ≤ 6.5 A, di/dt ≤ 300 A/ $\mu$ s, V $_{DD}$  ≤ BV $_{DSS}$ , starting T $_{J}$  = 25°C. 4. Essentially independent of operating temperature.

# **Typical Characteristics**

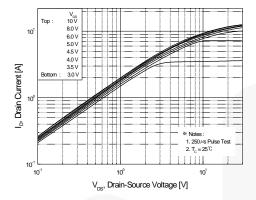


Figure 1. On-Region Characteristics

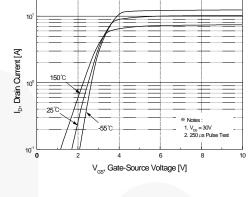


Figure 2. Transfer Characteristics

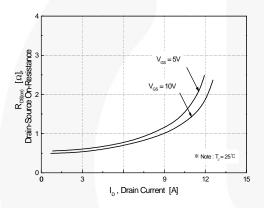


Figure 3. On-Resistance Variation vs.
Drain Current and Gate Voltage

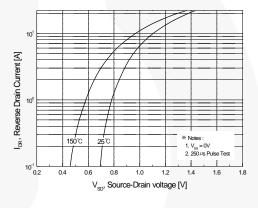


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

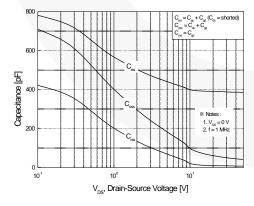


Figure 5. Capacitance Characteristics

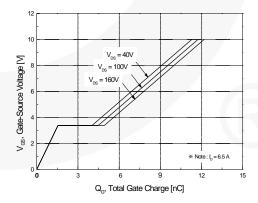


Figure 6. Gate Charge Characteristics

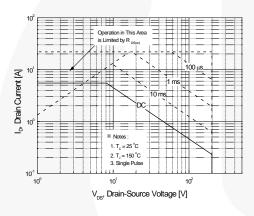
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Typical Characteristics (Continued)

Figure 7. Breakdown Voltage Variation vs. Temperature

T<sub>J</sub>, Junction Temperature [°C]

Figure 8. On-Resistance Variation vs. Temperature



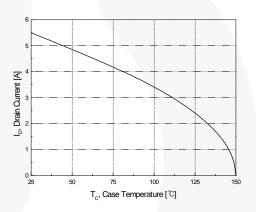


Figure 9. Maximum Safe Operating Area

Figure 10. Maximum Drain Current vs. Case Temperature

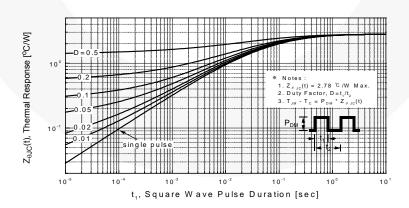


Figure 11. Transient Thermal Response Curve

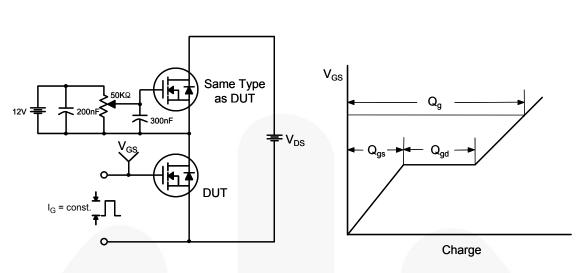


Figure 12. Gate Charge Test Circuit & Waveform

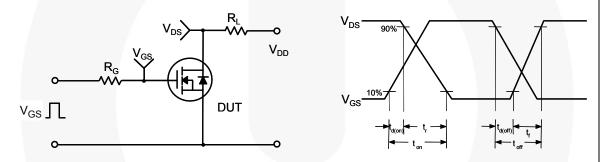


Figure 13. Resistive Switching Test Circuit & Waveforms

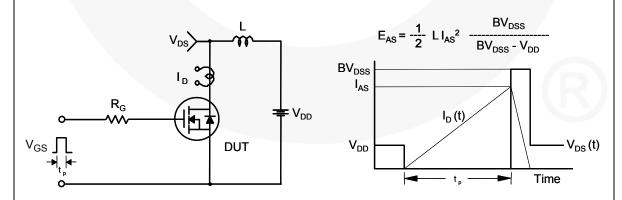
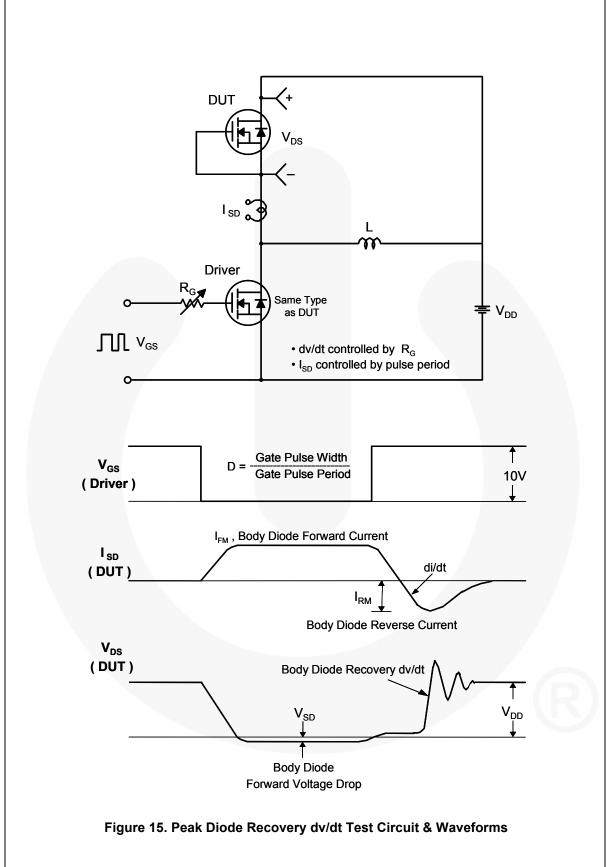


Figure 14. Unclamped Inductive Switching Test Circuit & Waveforms



# **Mechanical Dimensions**

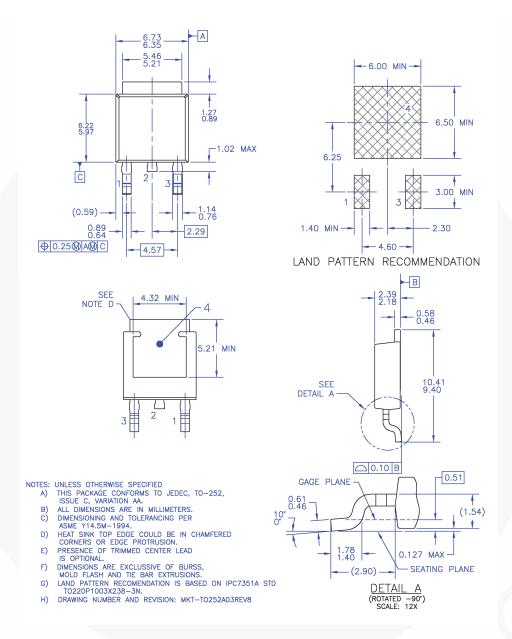


Figure 16. TO252 (D-PAK), Molded, 3-Lead, Option AA&AB

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